

TIL920, TIL921, TIL922, TIL920A, TIL921A, TIL922A TIL920B, TIL921B, TIL922B SINGLE/DUAL/QUAD CHANNEL OPTOCOUPLERS

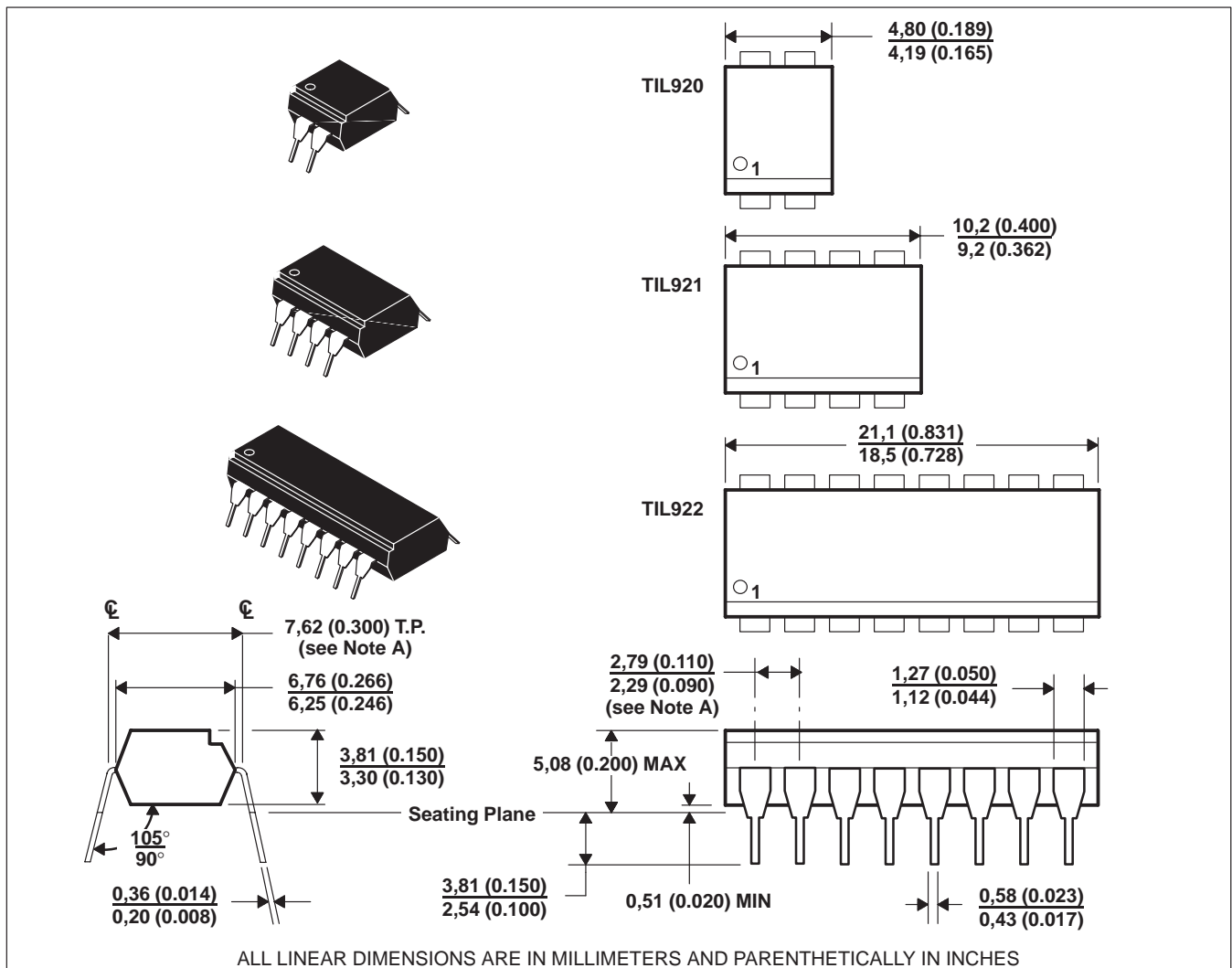
SOOS032-D3908, FEBRUARY 1992

- AC Signal Input
- Gallium-Arsenide Diode Infrared Source
- Source Is Optically Coupled to Silicon N-P-N Phototransistor
- Choice of One, Two, or Four Channels
- Choice of Three Current-Transfer Ratios
- High-Voltage Electrical Isolation . . . 7.5 kV Peak (5.3 kV rms)
- Plastic Dual-In-Line Packages
- UL Listed – File No. E65085

description

These optocouplers consist of two gallium-arsenide light-emitting diodes connected in a reverse-parallel configuration for ac-input applications and a silicon n-p-n phototransistor per channel. The TIL920 has one channel in a 4-pin package, the TIL921 has two channels in an 8-pin package, and the TIL922 has four channels in a 16-pin package. The standard devices, TIL920, TIL921, and TIL922, are tested for a current-transfer ratio of 20% minimum. Devices selected for a current-transfer ratio of 50% and 100% minimum are designated with the suffix A and B respectively.

mechanical data



NOTE A: Each pin centerline is located 0.25 (0.010) of its true longitudinal position.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

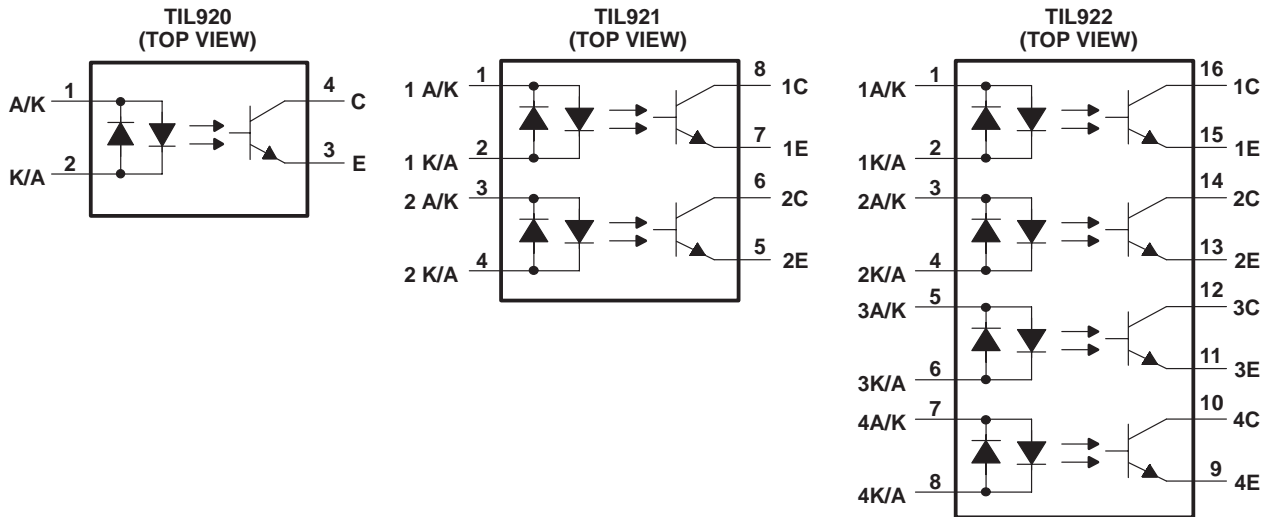
**TEXAS
INSTRUMENTS**

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TIL920, TIL921, TIL922, TIL920A, TIL921A, TIL922A
TIL920B, TIL921B, TIL922B
SINGLE/DUAL/QUAD CHANNEL OPTOCOUPLEDERS
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schematic diagrams



absolute maximum ratings, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

Input-to-output voltage (see Note 1)	± 7.5 kV peak or dc (± 5.3 kV rms)
Collector-emitter voltage (see Note 2)	35 V
Emitter-collector voltage	7 V
Input diode continuous forward current at (or below) 25°C free-air temperature (see Note 3)	± 50 mA
Continuous power dissipation at (or below) 25°C free-air temperature:	
Phototransistor (see Note 4)	150 mW
Input diode plus phototransistor per channel (see Note 5)	200 mW
Operating free-air temperature range, T_A	-55°C to 100°C
Storage temperature range	-55°C to 125°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C

- NOTES: 1. This rating applies for sine-wave operation at 50 or 60 Hz. Service capability is verified by testing in accordance with UL requirements.
2. This value applies when the base-emitter diode is open circuited.
3. Derate linearly to 100°C free-air temperature at the rate of 0.67 mA/ $^\circ\text{C}$.
4. Derate linearly to 100°C free-air temperature at the rate of 2 mW/ $^\circ\text{C}$.
5. Derate linearly to 100°C free-air temperature at the rate of 2.67 mW/ $^\circ\text{C}$.

electrical characteristics, $T_A = 25^\circ\text{C}$ (unless otherwise noted)

PARAMETER			TEST CONDITIONS		MIN	TYP	MAX	UNIT
$V_{(BR)CEO}$	Collector-emitter breakdown voltage		$I_C = 0.5\text{ mA}$,	$I_F = 0$	35			V
$V_{(BR)ECO}$	Emitter-collector breakdown voltage		$I_C = 100\text{ }\mu\text{A}$,	$I_F = 0$	7			V
$I_{C(off)}$	Off-state collector current		$V_{CE} = 24\text{ V}$,	$I_F = 0$			100	nA
CTR^\dagger	Current transfer ratio	TIL920, TIL921, TIL922	$I_F = 5\text{ mA}$,	$V_{CE} = 5\text{ V}$	20%			
		TIL920A, TIL921A, TIL922A			50%			
		TIL920B, TIL921B, TIL922B			100%			
V_F^\dagger	Input diode static forward voltage		$I_F = 20\text{ mA}$				1.4	V
$V_{CE(sat)}^\dagger$	Collector-emitter saturation voltage		$I_F = 5\text{ mA}$,	$I_C = 1\text{ mA}$			0.4	V
C_{io}	Input-to-output capacitance		$V_{in-out} = 0$, $f = 1\text{ MHz}$, See Note 6			1		pF
r_{io}	Input-to-output internal resistance		$V_{in-out} = \pm 1\text{ kV}$, See Note 6			10^{11}		Ω
$I_{C(on)1}$ $I_{C(on)2}$	On-state collector current symmetry ratio (see Note 7)		$V_{CE} = 5\text{ V}$, $I_F = 5\text{ mA}$		1		3	

† These parameters apply to either direction of the input current.

NOTES: 6. These parameters are measured between all input-diode leads shorted together and all phototransistor leads shorted together.

7. The higher of the two values of $I_{C(on)}$ generated by the two diodes is taken as $I_{C(on)1}$.

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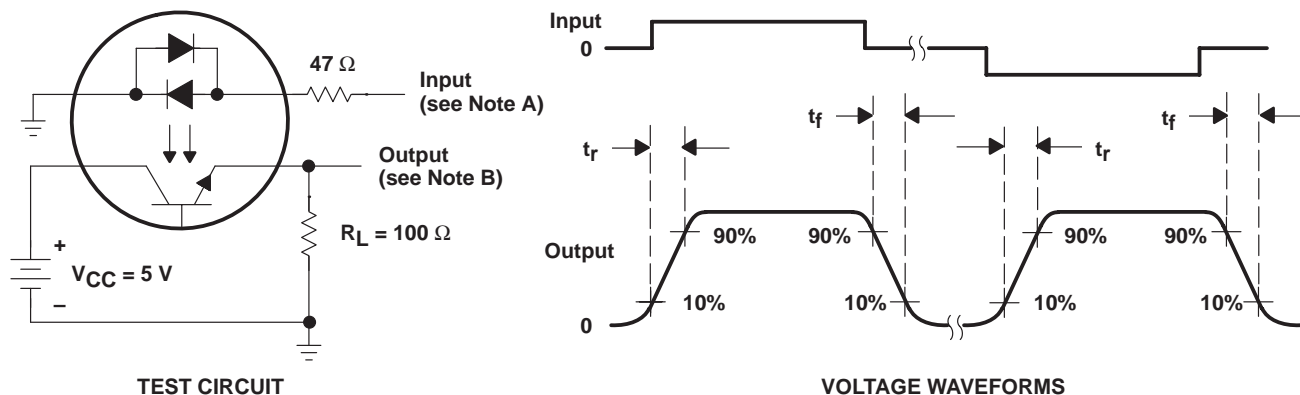
switching characteristics, $T_A = 25^\circ\text{C}$

PARAMETER†	TEST CONDITIONS	TYP	UNIT
t_r Rise time	$V_{CC} = 5\text{ V}$, $I_{C(on)} = 2\text{ mA}$, $R_L = 100\ \Omega$, See Figure 1	6	μs
t_f Fall time		6	

† These parameters apply to either direction of the input current.

PARAMETER MEASUREMENT INFORMATION

Adjust amplitude of input pulse for $I_{C(on)} = 2\text{ mA}$



NOTES: A. The input waveform is supplied by a generator with the following characteristics: $Z_0 = 50\ \Omega$, $t_r \leq 15\text{ ns}$, duty cycle = 1%.
B. The output waveform is monitored on an oscilloscope with the following characteristics: $t_r \leq 12\text{ ns}$, $R_i \geq 1\text{ M}\Omega$, $C_i \leq 20\text{ pF}$.

Figure 1. Switching Times

TYPICAL CHARACTERISTICS

INPUT CURRENT
vs
INPUT VOLTAGE

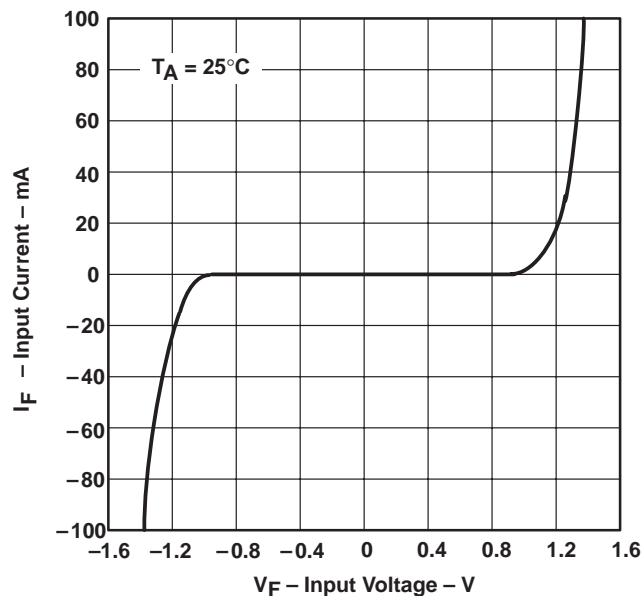


Figure 2

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TYPICAL CHARACTERISTICS

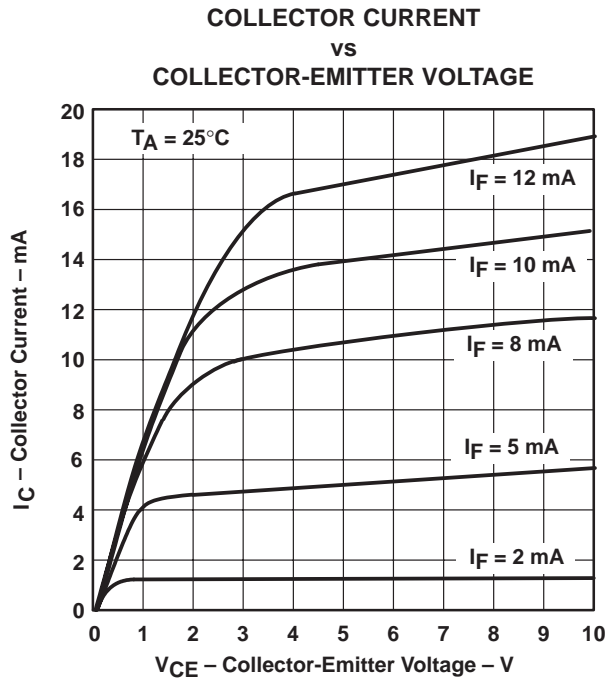


Figure 3

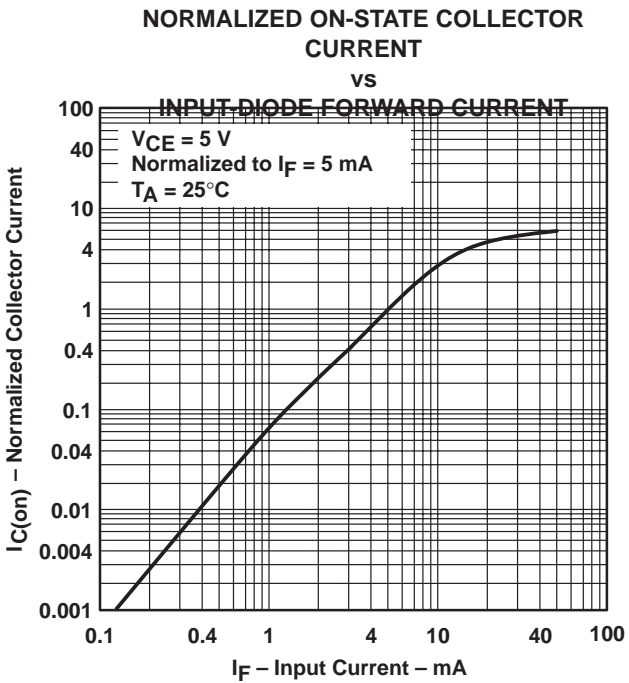


Figure 4

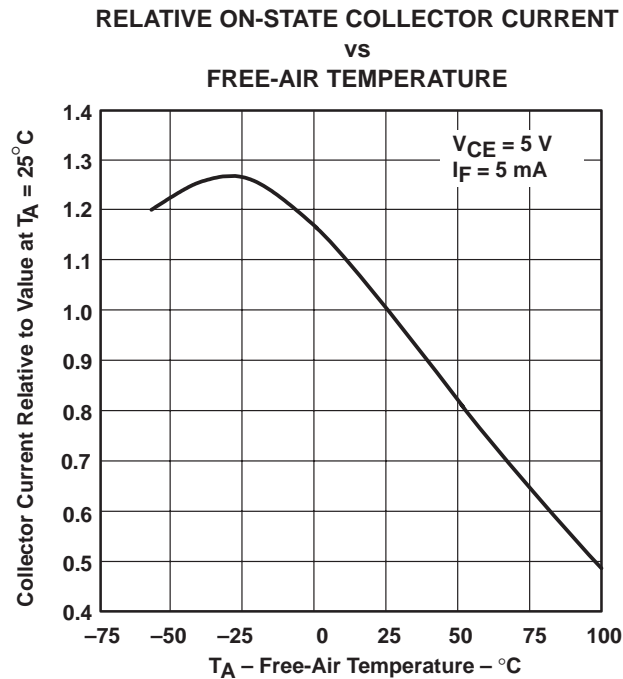


Figure 5

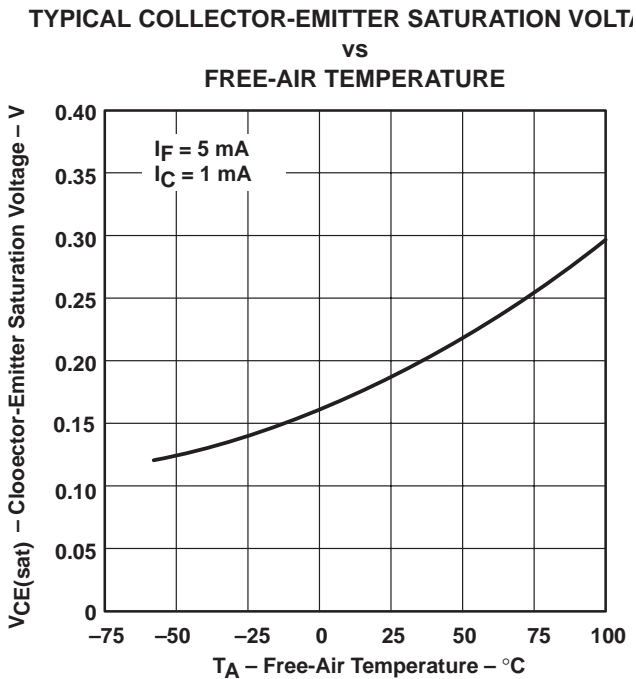


Figure 6

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
TIL920	OBSOLETE	PDIP	N	4		TBD	Call TI	Call TI
TIL920A	OBSOLETE	PDIP	N	4		TBD	Call TI	Call TI
TIL920B	OBSOLETE	PDIP	N	4		TBD	Call TI	Call TI
TIL921	OBSOLETE	PDIP	N	4		TBD	Call TI	Call TI
TIL921A	OBSOLETE	PDIP	N	4		TBD	Call TI	Call TI
TIL921B	OBSOLETE	PDIP	N	4		TBD	Call TI	Call TI
TIL922	OBSOLETE	PDIP	N	8		TBD	Call TI	Call TI
TIL922A	OBSOLETE	PDIP	N	8		TBD	Call TI	Call TI
TIL922B	OBSOLETE	PDIP	N	8		TBD	Call TI	Call TI

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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